



Encapsulation Solutions
for
TOPCon PV Modules

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杭州福斯特应用材料股份有限公司
HANGZHOU FIRST APPLIED MATERIAL CO., LTD.

Global Operation bases and Capacity

- 4 x Production Bases in China
- 2 x Overseas Production Bases
- Annual Production Capacities : **400GW** of Encapsulants, **50GW** of Backsheet



Thailand



Vietnam





Chapter 2

Encapsulation for Glass-Glass TOPCon Modules

DH Test : TOPCon G2G with different encapsulant combinations

Encapsulant	DH Test	Voc [V]	Isc [A]	F.F.	Pmax [W]	Power loss
F406PS+F406PS normal [EVA+EVA]	Initial	53.17	13.57	0.81	587.06	
	DH1000h	53.01	13.40	0.81	573.99	2.23%
	DH1500h	53.04	13.29	0.78	552.77	5.84%
	DH2000h	53.01	13.28	0.72	503.58	14.22%
S406(P)+S406(P) Low acid + PID enhance [EVA+EVA]	Initial	53.11	13.50	0.81	584.02	
	DH1000h	52.92	13.38	0.81	573.64	1.78%
	DH1500h	53.01	13.36	0.80	568.59	2.64%
	DH2000h	52.97	13.30	0.78	548.42	6.10%
EP304+F406PS [EPE+EVA]	Initial	53.15	13.62	0.81	587.23	/
	DH1000h	52.98	13.42	0.81	576.00	1.91%
	DH2000h	53.01	13.46	0.80	571.90	2.61%
	DH3000h	53.04	13.42	0.79	563.65	4.02%
EP304+EP304 [EPE+EPE]	Initial	53.18	13.54	0.82	586.93	/
	DH1000h	53.08	13.41	0.81	577.76	1.56%
	DH2000h	53.13	13.41	0.81	575.05	2.02%
	DH3000h	53.18	13.4	0.80	572.83	2.40%
TF4+TF4 [POE+POE]	Initial	53.20	13.56	0.82	587.79	/
	DH1000h	53.07	13.45	0.81	578.93	1.51%
	DH2000h	53.19	13.40	0.81	577.08	1.82%
	DH3000h	53.11	13.40	0.81	575.58	2.08%

TOPCon LECO cell A : Jan 2024 Lot

✓ Power loss of TOPCon G2G modules with **EPE** and **POE** were <3% after DH3000

✓ When TOPCon G2G modules were encapsulated with **S406(P) EVA (Low acid + PID enhance)**

- 6.1% Power loss after DH2000
- Still better than normal EVA

✓ This DH test results of TOPCon G2G modules are consistent with the water vapor barrier ability of the encapsulation film

WVTR: POE < EPE < EVA

PID results of TOPCon G2G

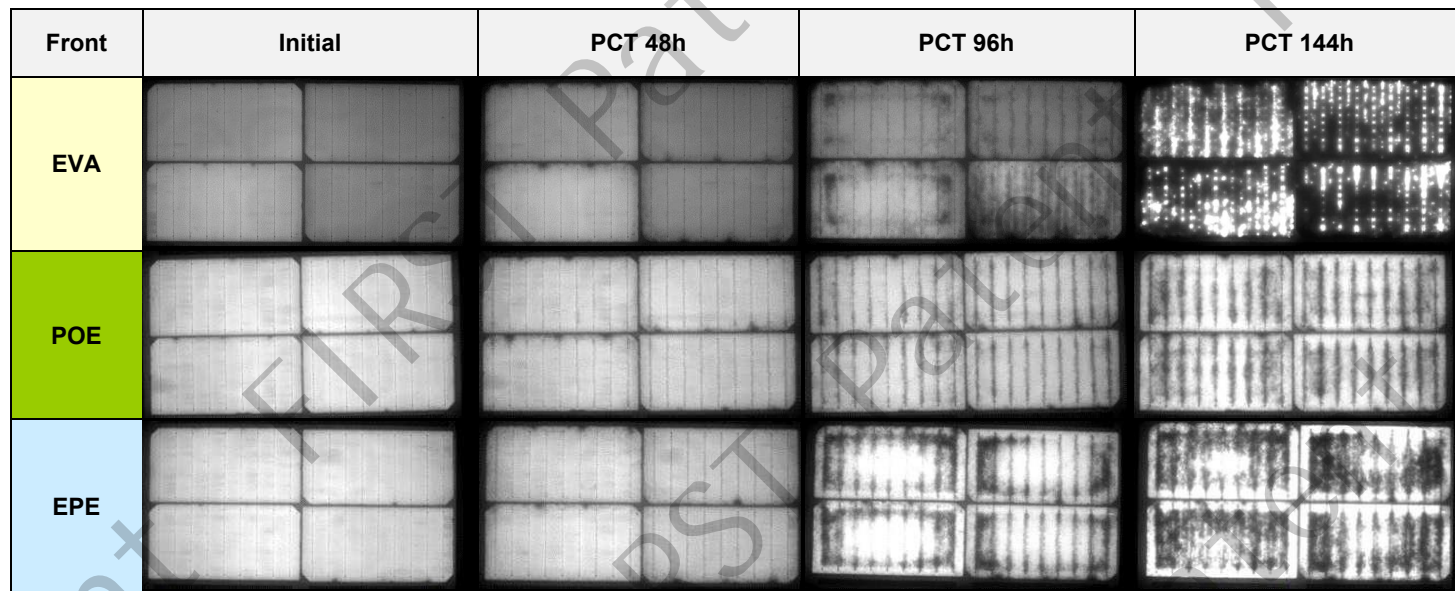
Encapsulant combination	Initial	PID 96h		PID 192h		PID288h	
		before recovery	UV2kWh	before recovery	UV2kWh	before recovery	UV2kWh
[EVA+EVA] F406PS+F406PS : normal		↓ 20.74%	↓ 0.62%	↓ 28.10%	↓ 2.24%	↓ 28.77%	↓ 5.80%
[EVA+EVA] S406(P)+S406(P) Low acid + PID enhance		↓ 21.45%	↓ 0.33%	↓ 27.70%	↓ 0.85%	↓ 28.51%	↓ 2.31%
[EPE+EVA] EP304+F406PS		↓ 0.34%	/	↓ 0.67%	/	↓ 1.32%	/
[EPE+EPE] EP304+EP304		↓ 0.29%	/	↓ 0.66%	/	↓ 1.27%	/



Chapter 3

Encapsulation for Glass-Backsheet TOPCon Modules

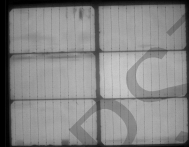
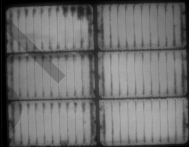
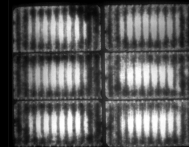
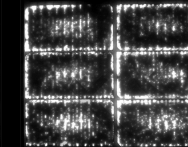
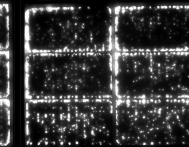
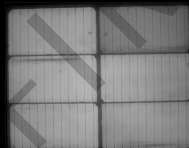


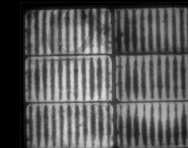
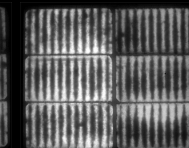
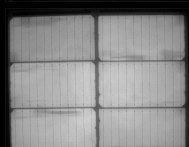

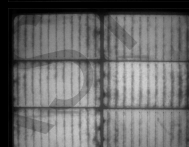
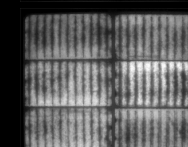
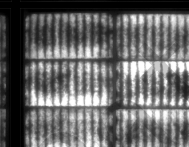





N-TOPCon G2B modules with conventional encapsulants



- Corrosion Rate : EVA≈ EPE > POE
- Even POE film still have a significant risk of corrosion

TF4N : Encapsulation Solution for N-TOPCon G2B modules

➤ TF4N POE on the front side : The best solution for N-TOPCon G2B modules

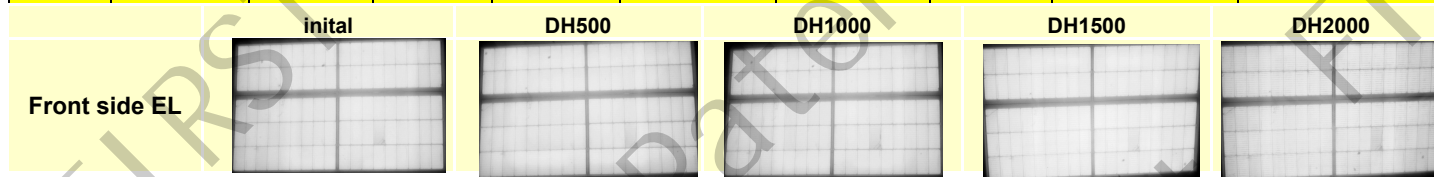
	PCT0	PCT48	PCT96	PCT144	PCT192
EVA					
EPE					
Competitor POE					
TF4N POE					

- Rear Encapsulant : F806W (white EVA)
- Backsheet: CPC white
- PCT: 121°C / 85%RH

TF4N : DH test results

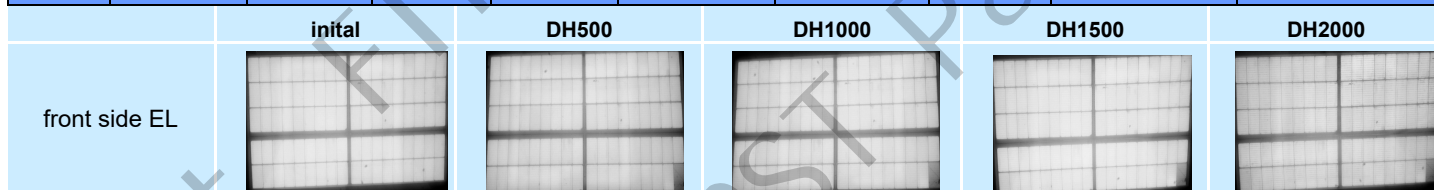
TF4N
+
F806W
+
CPC white

DH	Test Side	Voc [V]	Isc [A]	Vmax [V]	Imax [A]	Pmax [W]	F.F.	Temperature[°C]	Power Loss [%]
initial	front	32.12	13.23	26.50	12.55	332.46	0.78	24.3	/
500	front	32.26	13.33	26.32	12.61	332.05	0.77	25.1	0.13
1000	front	32.15	13.30	26.39	12.60	332.67	0.78	24.3	-0.06
1500	front	32.09	13.31	26.11	12.57	328.21	0.77	23.5	1.28
2000	front	32.13	13.35	25.58	12.38	321.70	0.75	25.1	3.24



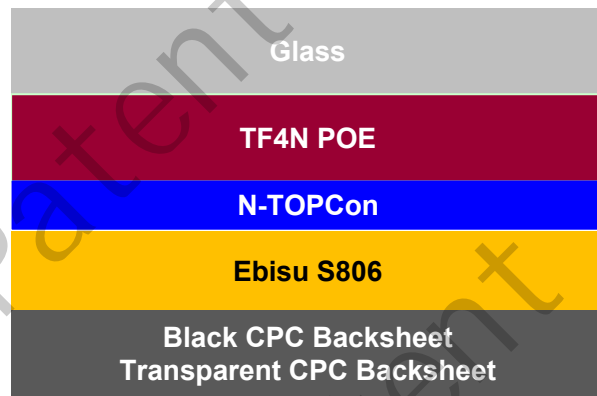
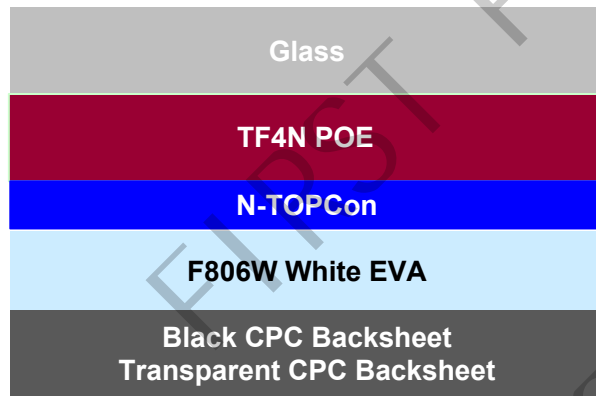
TF4N
+
S806
+
CPC black

DH	Test Side	Voc [V]	Isc [A]	Vmax [V]	Imax [A]	Pmax [W]	F.F.	Temperature[°C]	Power Loss [%]
initial	front	32.08	12.88	26.53	12.20	323.58	0.78	24.3	/
500	front	32.23	12.97	26.38	12.24	322.96	0.77	25.1	0.19
1000	front	32.08	12.93	26.40	12.23	322.92	0.78	24.3	0.21
1500	front	32.01	12.94	26.09	12.19	318.07	0.77	23.5	1.70
2000	front	32.08	12.99	25.57	12.04	312.54	0.75	25.1	3.41



➤ Both can pass twice the IEC test standard value

Encapsulation Solutions for TOPCon G2B modules



Competitive cost and reliability solution!

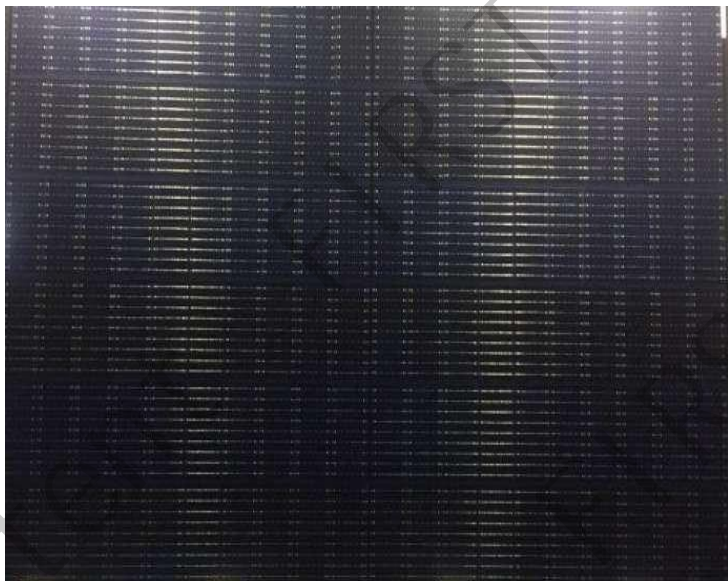


Chapter 5

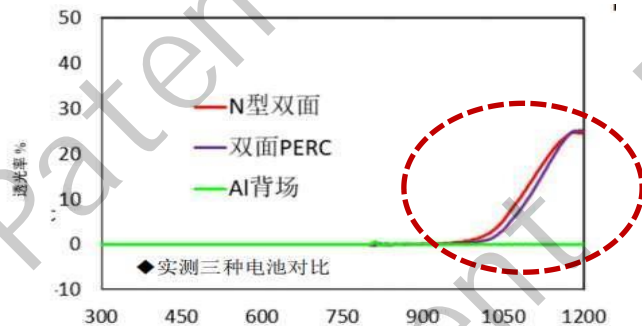
High Reflective (HR) Black Backsheet

High Reflective Black Backsheet (HRBB)

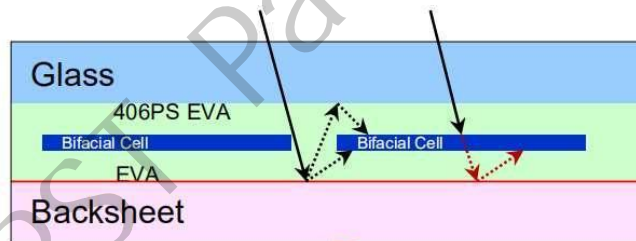
- High Reflective Black Backsheet is using non-metallic pigment system
- Reflect through cell-to-cell gap and transmission : Power boost



Module Appearance with High Reflective Black Backsheet



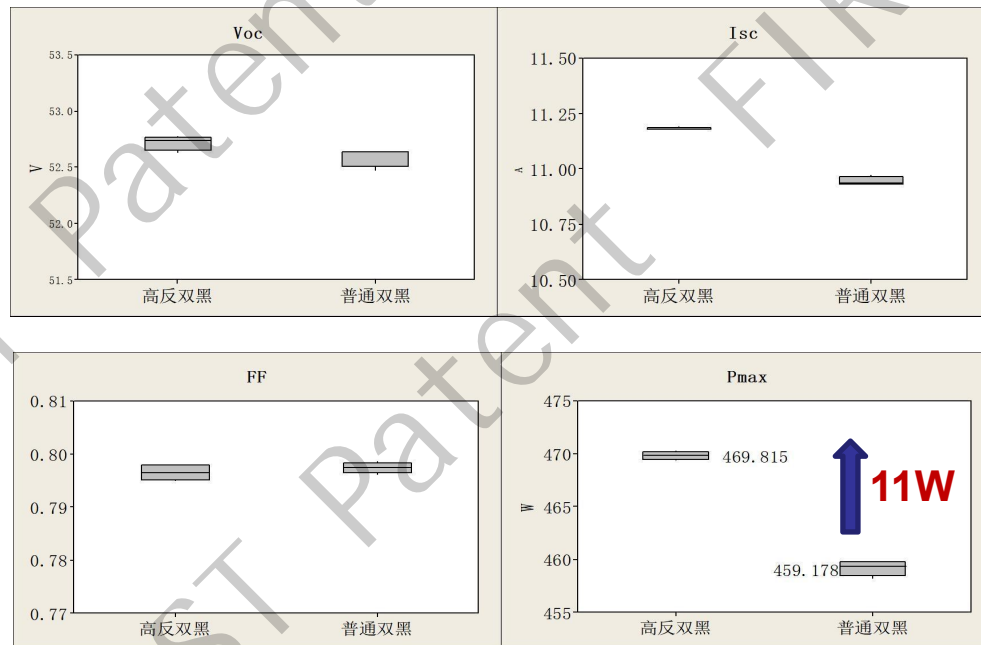
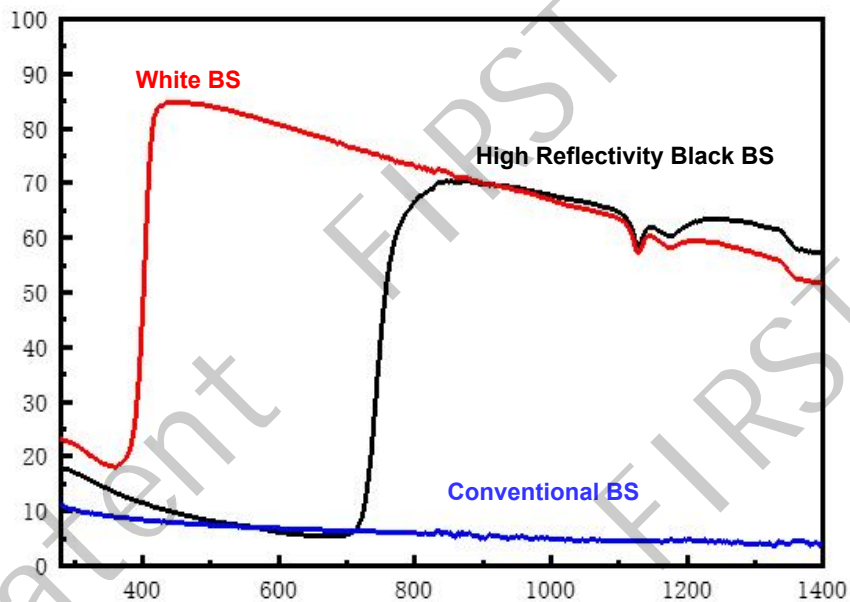
Light transmittance of the cells



Infrared light utilization path

High Reflective Black Backsheet (HRBB)

- High Reflectance at Infrared region : $\geq 70\%$
- Power gain $\geq 2\%$ (more than 5 W)



78 cells N-Topcon module between HRBB and common BB

Contact

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